# **ABLIC**

# S-8250B Series

#### **BATTERY PROTECTION IC FOR 1-CELL PACK**

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Rev 1.1 na

The S-8250B Series is a protection IC for 1-cell lithium-ion / lithium polymer rechargeable batteries and includes high-accuracy voltage detection circuits and delay circuits.

The S-8250B Series is suitable for protecting 1-cell lithium-ion / lithium polymer rechargeable battery packs from overcharge, overdischarge and overcurrent. By adjusting power supply voltage dependency of discharge overcurrent detection voltage in accordance with ON resistance of the charge-discharge control FET, the S-8250B Series realizes high-accuracy discharge overcurrent detection.

#### ■ Features

• High-accuracy discharge overcurrent detection circuit

Discharge overcurrent detection voltage 0.050 V to 0.150 V (1 mV step) Accuracy  $\pm 10 \text{ mV}$  (Ta =  $\pm 25^{\circ}\text{C}$ ) (Power supply voltage dependency can be set in accordance with ON resistance of the charge-discharge control FET.)

• High-accuracy voltage detection circuit

Overcharge detection voltage 4.100 V to 4.600 V (5 mV step) Accuracy  $\pm$ 20 mV (Ta =  $\pm$ 25°C)

Accuracy  $\pm 25$  mV (Ta =  $-10^{\circ}$ C to  $+60^{\circ}$ C)

• Detection delay times are generated only by an internal circuit (External capacitors are unnecessary).

• 0 V battery charge function is selectable: Available, unavailable

Power-down function is selectable: Available, unavailable

• Release condition of discharge overcurrent status is selectable: Load disconnection, charger connection

High-withstand voltage:

VM pin and CO pin: Absolute maximum rating 28 V

• Wide operation temperature range: Ta = -40°C to +85°C

• Low current consumption

During operation: 2.0  $\mu$ A typ., 4.0  $\mu$ A max. (Ta = +25°C)

During power-down: 50 nA max. (Ta = +25°C)

• Lead-free (Sn 100%), halogen-free

- \*1. Overcharge release voltage = Overcharge detection voltage Overcharge hysteresis voltage (Overcharge hysteresis voltage can be selected from a range of 0 V to 0.4 V in 50 mV step.)
- \*2. Overdischarge release voltage = Overdischarge detection voltage + Overdischarge hysteresis voltage (Overdischarge hysteresis voltage can be selected from a range of 0 V to 0.7 V in 100 mV step.)

#### ■ Applications

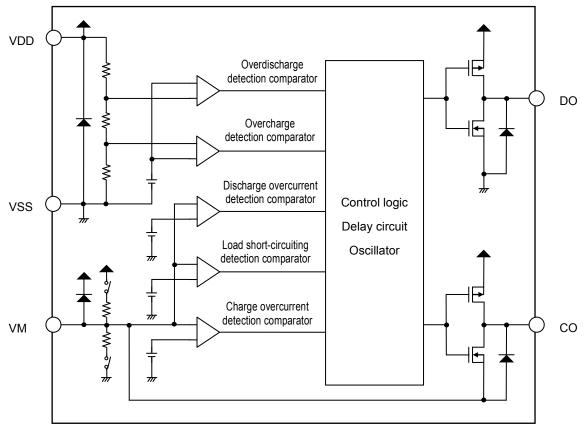
- Lithium-ion rechargeable battery pack
- Lithium polymer rechargeable battery pack

#### ■ Package

• SNT-6A

# **■** Block Diagram

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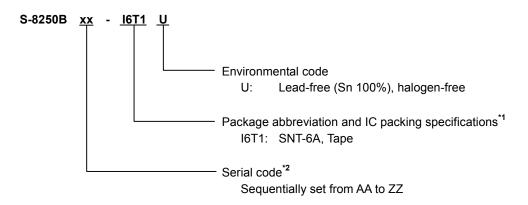


Remark All the diodes shown in the figure are parasitic diodes.

Figure 1

#### **■ Product Name Structure**

#### 1. Product name



- \*1. Refer to the tape drawing.
- \*2. Refer to "3. Product name list".

#### 2. Package

**Table 1 Package Drawing Codes** 

Package Name Dimension		Tape	Reel	Land
SNT-6A	PG006-A-P-SD	PG006-A-C-SD	PG006-A-R-SD	PG006-A-L-SD

#### 3. Product name list

#### 3.1 SNT-6A

Table 2 (1 / 2)

Product Name	Overcharge Detection Voltage [V <sub>CU</sub> ]	Overcharge Release Voltage [V <sub>CL</sub> ]	Overdischarge Detection Voltage [V <sub>DL</sub> ]	Overdischarge Release Voltage [V <sub>DU</sub> ]	Delay Time Combination <sup>*1</sup>	Function Combination*2
S-8250BAB-I6T1U	4.425 V	4.225 V	2.500 V	2.900 V	(1)	(2)
S-8250BAC-I6T1U	4.415 V	4.215 V	2.500 V	2.900 V	(1)	(2)
S-8250BAF-I6T1U	4.425 V	4.225 V	2.300 V	2.500 V	(1)	(1)
S-8250BAK-I6T1U	4.425 V	4.225 V	2.300 V	2.500 V	(1)	(1)
S-8250BAL-I6T1U	4.425 V	4.225 V	2.500 V	2.800 V	(2)	(1)
S-8250BAM-I6T1U	4.475 V	4.275 V	2.500 V	2.900 V	(3)	(2)
S-8250BAN-I6T1U	4.470 V	4.220 V	2.300 V	2.300 V	(4)	(3)
S-8250BAS-I6T1U	4.280 V	4.280 V	2.800 V	2.800 V	(5)	(4)
S-8250BAV-I6T1U	4.330 V	4.130 V	2.000 V	2.000 V	(1)	(2)

Table 2 (2 / 2)

Product Name			Load Short-circuiting Detection Voltage	Charge Overcurrent Detection Voltage	
	$V_{DD} = 3.0 \text{ V}$	$V_{DD} = 3.4 \text{ V}$	$V_{DD} = 4.0 \text{ V}$	[V <sub>SHORT</sub> ]	[V <sub>CIOV</sub> ]
S-8250BAB-I6T1U	0.134 V	0.125 V	0.115 V	0.300 V	-0.100 V
S-8250BAC-I6T1U	0.060 V	0.056 V	0.050 V	0.700 V	−0.050 V
S-8250BAF-I6T1U	0.072 V	0.069 V	0.066 V	0.225 V	-0.040 V
S-8250BAK-I6T1U	0.104 V	0.097 V	0.089 V	0.225 V	−0.055 V
S-8250BAL-I6T1U	0.061 V	0.060 V	0.057 V	0.250 V	−0.055 V
S-8250BAM-I6T1U	0.071 V	0.068 V	0.063 V	0.200 V	−0.050 V
S-8250BAN-I6T1U	0.113 V	0.108 V	0.100 V	0.500 V	−0.075 V
S-8250BAS-I6T1U	0.054 V	0.052 V	0.050 V	0.500 V	−0.100 V
S-8250BAV-I6T1U	0.110 V	0.100 V	0.091 V	0.300 V	−0.050 V

<sup>\*1.</sup> Refer to **Table 3** about the details of the delay time combinations.

**Remark** Please contact our sales office for the products with detection voltage value other than those specified above.

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<sup>\*2.</sup> Refer to **Table 5** about the details of the function combinations.

#### Table 3

Delay Time Combination	Overcharge Detection Delay Time [t <sub>CU</sub> ]	Overdischarge Detection Delay Time [t <sub>DL</sub> ]	Discharge Overcurrent Detection Delay Time [tblov]	Load Short-circuiting Detection Delay Time [tshort]	Charge Overcurrent Detection Delay Time [t <sub>ClOV</sub> ]
(1)	1.0 s	32 ms	8 ms	280 μs	8 ms
(2)	1.0 s	64 ms	8 ms	280 μs	8 ms
(3)	1.0 s	64 ms	16 ms	280 μs	8 ms
(4)	1.0 s	32 ms	16 ms	280 μs	16 ms
(5)	1.0 s	64 ms	16 ms	280 μs	16 ms

Remark The delay times can be changed within the range listed in Table 4. For details, please contact our sales office.

#### Table 4

Delay Time	Symbol	Se	Selection Range		Remark
Overcharge detection delay time	t <sub>CU</sub>	256 ms	512 ms	1.0 s*1	Select a value from the left.
Overdischarge detection delay time	t <sub>DL</sub>	32 ms	64 ms	128 ms*1	Select a value from the left.
Discharge overcurrent detection delay time	t <sub>DIOV</sub>	8 ms	16 ms*1	32 ms	Select a value from the left.
Load short-circuiting detection delay time	t <sub>SHORT</sub>	280 μs <sup>*1</sup>	530 μs	_	Select a value from the left.
Charge overcurrent detection delay time	t <sub>CIOV</sub>	8 ms	16 ms*1	32 ms	Select a value from the left.

<sup>\*1.</sup> This value is the delay time of the standard products.

#### Table 5

Function Combination	0 V Battery Charge Function <sup>*1</sup>	Power-down Function*2	Release Condition of Discharge Overcurrent Status <sup>*3</sup>
(1)	Available	Unavailable	Load disconnection
(2)	Unavailable	Unavailable	Load disconnection
(3)	Unavailable	Available	Load disconnection
(4)	Available	Available	Load disconnection

<sup>\*1. 0</sup> V battery charge function "available" / "unavailable" is selectable.

Remark Please contact our sales office for the products with function combinations other than those specified above.

<sup>\*2.</sup> Power-down function "available" / "unavailable" is selectable.

<sup>\*3.</sup> Release condition of discharge overcurrent status "load disconnection" / "charger connection" is selectable.

# **■** Pin Configuration

#### 1. SNT-6A

Top view



Figure 2

#### Table 6

Pin No.	Symbol	Description
1	NC <sup>*1</sup>	No connection
2	СО	Connection pin of charge control FET gate (CMOS output)
3	DO	Connection pin of discharge control FET gate (CMOS output)
4	VSS	Input pin for negative power supply
5	VDD	Input pin for positive power supply
6	VM	Voltage detection pin between VM pin and VSS pin (Overcurrent / charger detection pin)

NC pin can be connected to VDD pin or VSS pin.

**<sup>\*1.</sup>** NC pin is electrically open.

### ■ Absolute Maximum Ratings

Table 7

(Ta = +25°C unless otherwise specified)

Item	Symbol	Applied pin	Absolute Maximum Rating	Unit
Input voltage between VDD pin and VSS pin	V <sub>DS</sub>	VDD	$V_{SS}-0.3$ to $V_{SS}+12$	V
VM pin input voltage	$V_{VM}$	VM	$V_{DD}-28 \ to \ V_{DD}+0.3$	V
DO pin output voltage	$V_{DO}$	DO	$V_{\text{SS}} - 0.3$ to $V_{\text{DD}} + 0.3$	V
CO pin output voltage	V <sub>CO</sub>	СО	$V_{VM}-0.3$ to $V_{DD}+0.3$	V
Power dissipation	$P_D$	_	400 <sup>*1</sup>	mW
Operation ambient temperature	T <sub>opr</sub>	_	−40 to +85	°C
Storage temperature	T <sub>stg</sub>	_	−55 to +125	°C

\*1. When mounted on board

[Mounted board]

(1) Board size:  $114.3 \text{ mm} \times 76.2 \text{ mm} \times t1.6 \text{ mm}$ (2) Board name: JEDEC STANDARD51-7

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

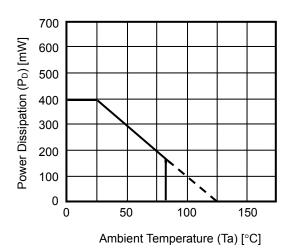


Figure 3 Power Dissipation of Package (When Mounted on Board)

### **■** Electrical Characteristics

#### 1. Ta = +25°C

Table 8

 $(Ta = +25^{\circ}C \text{ unless otherwise specified})$ 

Detection Voltage   Vcu			(Ta = $+25$ °C unless otherwise specifications)						
Vocarbarge detection voltage   Vocarbarge detection voltage   Vocarbarge release voltage   Vocarbarg	Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit	
Voc   Ta = -10°C to +60°C°T   Voc   -0.025   Voc   Voc   +0.025   V   1	Detection Voltage								
Tall = -10 **C to +e0 **C	Overally and detection will an	.,	_	V <sub>CU</sub> - 0.020	Vcu	V <sub>CU</sub> + 0.020	V	1	
Overdischarge release voltage   Vol.   Vo	Overcharge detection voltage	Vcu	Ta = $-10^{\circ}$ C to $+60^{\circ}$ C <sup>*1</sup>	V <sub>CU</sub> - 0.025	Vcu	V <sub>CU</sub> + 0.025	V	1	
Vocal	Overal and a second term	.,	V <sub>CL</sub> ≠ V <sub>CU</sub>	V <sub>CL</sub> - 0.030	V <sub>CL</sub>	V <sub>CL</sub> + 0.030	V	1	
$V_{\text{DU}} = V_{\text{DU}} = V_{\text{DU}} = V_{\text{DU}} = V_{\text{DU}} = V_{\text{DU}} = 0.100 = V_{\text{DU}} = 0.050 = V_{\text{DU}} = 0.010 = V_{\text$	Overcharge release voltage	VCL	$V_{CL} = V_{CU}$	$V_{CL} - 0.025$	$V_{CL}$	$V_{CL} + 0.020$	V	1	
Vot	Overdischarge detection voltage	$V_{DL}$	_	$V_{DL}-0.050$	$V_{DL}$	$V_{DL} + 0.050$	V	2	
Vote = Vota	Overdischerge relegee veltage	.,	$V_{DL} \neq V_{DU}$	$V_{DU}-0.100$	$V_{DU}$	$V_{DU} + 0.100$	V	2	
Discharge overcurrent detection voltage   V_DoD   V	Overdischarge release voltage	<b>V</b> DU	$V_{DL} = V_{DU}$	$V_{\text{DU}}-0.050$	$V_{DU}$	$V_{DU} + 0.050$	V	2	
Von = 4.0 V   Von = 0.010   Von			$V_{DD} = 3.0 \text{ V}$	$V_{\text{DIOV}}-0.010$	$V_{\text{DIOV}}$	$V_{DIOV} + 0.010$	V	2	
December   Construction   Constru	Discharge overcurrent detection voltage	$V_{\text{DIOV}}$	V <sub>DD</sub> = 3.4 V	$V_{\text{DIOV}}-0.010$	$V_{\text{DIOV}}$	$V_{DIOV} + 0.010$	V	2	
Vocation			V <sub>DD</sub> = 4.0 V	$V_{\text{DIOV}}-0.010$	$V_{\text{DIOV}}$	$V_{DIOV} + 0.010$	V	2	
O V Dattery Charge Punction   V O V O V O V O V O V O V O V O V O V	Load short-circuiting detection voltage	$V_{\text{SHORT}}$	_	V <sub>SHORT</sub> - 0.050	V <sub>SHORT</sub>	V <sub>SHORT</sub> + 0.050	V	2	
Charge overcurrent detection voltage   V <sub>ClOV</sub>   -   V <sub>ClOV</sub> - 0.015   V <sub>ClOV</sub>   V <sub>ClOV</sub> + 0.015   V   2   2   2   2   2   2   2   2   2	Discharge overcurrent release voltage	V <sub>RIOV</sub>	_	V <sub>DD</sub> – 1.2		$V_{\text{DD}}-0.5$	٧	2	
O V Battery Charge Function   O V battery charge starting charger voltage   O V battery charge function "available"   O.00   O.70   1.00   V   2	Charge overcurrent detection voltage	V <sub>CIOV</sub>	_	V <sub>CIOV</sub> - 0.015	V <sub>CIOV</sub>	V <sub>CIOV</sub> + 0.015	V	2	
function "available"   0.00   0.70   1.00   V   2	0 V Battery Charge Function								
The provided properties of the properties of th	0 V battery charge starting charger voltage	V <sub>0CHA</sub>	, ,	0.00	0.70	1.00	V	2	
Resistance between VM pin and VDD pin RVMD	0 V battery charge inhibition battery voltage	V <sub>0INH</sub>	, ,	0.90	1.25	1.60	٧	2	
Resistance between VM pin and VSS pin R <sub>VMS</sub> $-$ 10 20 40 $k\Omega$ 3 nput Voltage Deperation voltage between VDD pin and VSS pin $V_{DSOP1}$ $-$ 1.5 $-$ 6.5 $V_{DSOP2}$ $-$ 1.5 $-$ 28 $V_{DSOP2}$ $-$ 20 4.0 $V_{DSOP2$	Internal Resistance								
Departion voltage between VDD pin and VDSOP1   -   1.5   -   6.5   V   -   -   -     -	Resistance between VM pin and VDD pin	$R_{VMD}$	_	500	1000	2000	kΩ	3	
Operation voltage between VDD pin and VDSOP1 $-$ 1.5 $-$ 6.5 $V$ $-$ Operation voltage between VDD pin and VDSOP2 $-$ 1.5 $-$ 28 $V$ $-$ Operation voltage between VDD pin and VDSOP2 $-$ 1.5 $-$ 28 $V$ $-$ Operation voltage between VDD pin and VDSOP2 $-$ 1.5 $-$ 28 $V$ $-$ Operation voltage between VDD pin and VDSOP2 $-$ 1.5 $-$ 28 $V$ $-$ Operation voltage between VDD pin and VDSOP2 $-$ 1.5 $-$ 28 $V$ $-$ Operation voltage between VDD pin and VDSOP2 $-$ 1.5 $-$ 28 $V$ $-$ Operation voltage between VDD pin and VDSOP2 $-$ 2.0 $+$ 4.0 $+$ 5 $+$ 6.5 $+$ 6	Resistance between VM pin and VSS pin	R <sub>VMS</sub>	_	10	20	40	kΩ	3	
Vosopi $\sqrt{\text{DSOP1}}$ $ 1.5$ $ 8.5$ $\sqrt{\text{DSOP2}}$ $         -$	Input Voltage								
M pin $V_{DSOP2}$ $ 1.5$ $ 28$ $V$ $         -$	Operation voltage between VDD pin and VSS pin	V <sub>DSOP1</sub>	_	1.5	-	6.5	V	_	
Current consumption during operation $I_{OPE}$ $  2.0$ $4.0$ $\mu A$ $3$ Current consumption during power-down $I_{PDN}$ $   50$ $nA$ $3$ Current consumption during overdischarge $I_{OPED}$ $   1.0$ $\mu A$ $3$ Current consumption during overdischarge $I_{OPED}$ $   1.0$ $\mu A$ $3$ Current consumption during overdischarge $I_{OPED}$ $   1.0$ $\mu A$ $3$ Current consumption during overdischarge $I_{OPED}$ $         -$	Operation voltage between VDD pin and VM pin	V <sub>DSOP2</sub>	_	1.5	-	28	٧	-	
Current consumption during power-down $\  \  \  \  \  \  \  \  \  \  \  \  \ $	Input Current								
Current consumption during overdischarge $  l_{OPED}  $ $   1.0$ $\mu A$ 3 Dutput Resistance  CO pin resistance "H" $  R_{COH}  $ $   5$ $  10$ $  20$ $  k\Omega  $ 4 CO pin resistance "L" $  R_{COL}  $ $   5$ $  10$ $  20$ $  k\Omega  $ 4 DO pin resistance "H" $  R_{DOH}  $ $   5$ $  10$ $  20$ $  k\Omega  $ 4 DO pin resistance "L" $  R_{DOH}   $ $   5$ $  10$ $  20$ $  k\Omega  $ 4 DO pin resistance "L" $  R_{DOL}   $ $   5$ $  10$ $  20$ $  k\Omega  $ 4 DO pin resistance "L" $  R_{DOL}   $ $   5$ $  10$ $  20$ $  k\Omega  $ 4 DO pin resistance "L" $  R_{DOL}   $ $   5$ $  10$ $  20$ $  k\Omega  $ 4 Do pin resistance "L" $  R_{DOL}   $ $   5$ $  10$ $  $	Current consumption during operation	I <sub>OPE</sub>	_	_	2.0	4.0	μА	3	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Current consumption during power-down	I <sub>PDN</sub>	_	_	1	50	nΑ	3	
CO pin resistance "H" $R_{COH}$ $ 5$ $10$ $20$ $k\Omega$ $4$ $\Omega$ O pin resistance "L" $R_{COL}$ $ 5$ $10$ $20$ $k\Omega$ $4$ $\Omega$ O pin resistance "H" $R_{DOH}$ $ 5$ $10$ $20$ $k\Omega$ $4$ $\Omega$ O pin resistance "L" $\Omega$	Current consumption during overdischarge	I <sub>OPED</sub>	_	_	-	1.0	μА	3	
CO pin resistance "L" $R_{COL}$ - 5 10 20 $k\Omega$ 4 DO pin resistance "H" $R_{DOH}$ - 5 10 20 $k\Omega$ 4 DO pin resistance "L" $R_{DOL}$ - 5 10 20 $k\Omega$ 4 DO pin resistance "L" $R_{DOL}$ - 5 10 20 $k\Omega$ 4 DO pin resistance "L" $R_{DOL}$ - 5 10 20 $k\Omega$ 4 DO pin resistance "L" $R_{DOL}$ - 5 10 20 $k\Omega$ 5 10 20 $k\Omega$ 4 DO pin resistance "L" $R_{DOL}$ - 5 10 20 $R_{DOL}$ 4 DO pin resistance "L" $R_{DOL}$ - 5 10 20 $R_{DOL}$ 4 DO pin resistance "L" $R_{DOL}$ - 5 10 20 $R_{DOL}$ 4 DO pin resistance "L" $R_{DOL}$ - 5 10 20 $R_{DOL}$ 4 DO pin resistance "L" $R_{DOL}$ - 5 10 20 $R_{DOL}$ 4 DO pin resistance "L" $R_{DOL}$ - 5 10 20 $R_{DOL}$ 4 DO pin resistance "L" $R_{DOL}$ - 5 10 20 $R_{DOL}$ 4 DO pin resistance "L" $R_{DOL}$ 4	Output Resistance				-		a.		
DO pin resistance "H" $R_{DOH}$ - 5 10 20 $k\Omega$ 4 DO pin resistance "L" $R_{DOL}$ - 5 10 20 $k\Omega$ 4 DO pin resistance "L" $R_{DOL}$ - 5 10 20 $k\Omega$ 4 Delay Time $R_{DOL}$ - $R_$	CO pin resistance "H"	R <sub>COH</sub>	_	5	10	20	kΩ	4	
Do pin resistance "L" $R_{DOL}$ - 5 10 20 $k\Omega$ 4 Delay Time  Divercharge detection delay time $t_{CU}$ - $t_{CU} \times 0.8$ $t_{CU}$ $t_{CU} \times 1.2$ - 5 Discharge overcurrent detection delay time $t_{DIOV}$ - $t_{DIOV} \times 0.8$ $t_{DIOV}$ $t_{DIOV} \times 1.2$ - 5 Discharge overcurrent detection delay time $t_{DIOV}$ - $t_{DIOV} \times 0.8$ $t_{DIOV}$ $t_{DIOV} \times 1.2$ - 5 Discharge overcurrent detection delay time $t_{SHORT}$ - $t_{SHORT} \times 0.7$ $t_{SHORT}$ $t_{SHORT} \times 1.3$ - 5	CO pin resistance "L"	R <sub>COL</sub>	-	5	10	20	kΩ	4	
Delay Time  Overcharge detection delay time $t_{CU}$ - $t_{CU} \times 0.8$ $t_{CU}$ $t_{CU} \times 1.2$ - 5  Overdischarge detection delay time $t_{DL}$ - $t_{DL} \times 0.8$ $t_{DL}$ $t_{DL} \times 1.2$ - 5  Discharge overcurrent detection delay time $t_{DIOV}$ - $t_{DIOV} \times 0.8$ $t_{DIOV}$ $t_{DIOV} \times 1.2$ - 5  Load short-circuiting detection delay time $t_{SHORT}$ - $t_{SHORT} \times 0.7$ $t_{SHORT} \times 1.3$ - 5	DO pin resistance "H"	R <sub>DOH</sub>	-	5	10	20	kΩ	4	
Overcharge detection delay time $t_{CU}$ - $t_{CU} \times 0.8$ $t_{CU}$ $t_{CU} \times 1.2$ - 5 Overdischarge detection delay time $t_{DL}$ - $t_{DL} \times 0.8$ $t_{DL}$ $t_{DL} \times 1.2$ - 5 Discharge overcurrent detection delay time $t_{DIOV}$ - $t_{DIOV} \times 0.8$ $t_{DIOV} \times 1.2$ - 5 Load short-circuiting detection delay time $t_{SHORT}$ - $t_{SHORT} \times 0.7$ $t_{SHORT} \times 1.3$ - 5	DO pin resistance "L"	R <sub>DOL</sub>	_	5	10	20	kΩ	4	
Overdischarge detection delay time $t_{DL}$ - $t_{DL} \times 0.8$ $t_{DL}$ $t_{DL} \times 1.2$ - 5 Discharge overcurrent detection delay time $t_{DIOV}$ - $t_{DIOV} \times 0.8$ $t_{DIOV} \times 1.2$ - 5 Load short-circuiting detection delay time $t_{SHORT}$ - $t_{SHORT} \times 0.7$ $t_{SHORT} \times 1.3$ - 5	Delay Time								
Discharge overcurrent detection delay time $t_{DIOV}$ - $t_{DIOV} \times 0.8$ $t_{DIOV} \times 1.2$ - 5 Load short-circuiting detection delay time $t_{SHORT}$ - $t_{SHORT} \times 0.7$ $t_{SHORT} \times 1.3$ - 5	Overcharge detection delay time	tcu	-	$t_{\text{CU}} \times 0.8$	tcu	t <sub>CU</sub> × 1.2		5	
Load short-circuiting detection delay time $t_{SHORT}$ - $t_{SHORT} \times 0.7$ $t_{SHORT}$ $t_{SHORT} \times 1.3$ - 5	Overdischarge detection delay time	t <sub>DL</sub>	-	$t_{\text{DL}}\times 0.8$	$t_{DL}$	$t_{DL} \times 1.2$		5	
	Discharge overcurrent detection delay time	t <sub>DIOV</sub>	-	$t_{\text{DIOV}} \times 0.8$	t <sub>DIOV</sub>	$t_{DIOV} \times 1.2$		5	
	Load short-circuiting detection delay time	t <sub>SHORT</sub>	-	$t_{\text{SHORT}} \times 0.7$	t <sub>SHORT</sub>	$t_{\text{SHORT}} \times 1.3$		5	
	Charge overcurrent detection delay time	tciov	_	$t_{\text{CIOV}} \times 0.8$	tciov	$t_{\text{CIOV}} \times 1.2$		5	

**<sup>\*1.</sup>** Since products are not screened at high and low temperature, the specification for this temperature range is guaranteed by design, not tested in production.

### 2. Ta = $-40^{\circ}$ C to $+85^{\circ}$ C<sup>\*1</sup>

Table 9

(Ta = -40°C to +85°C<sup>\*1</sup> unless otherwise specified)

			(14 10 0 1	<del>5 100 0</del>	unicas otnerw	oc op	oomou)
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Detection Voltage							
Overcharge detection voltage	V <sub>CU</sub>	_	V <sub>CU</sub> - 0.045	V <sub>CU</sub>	V <sub>CU</sub> + 0.030	V	1
-		V <sub>CL</sub> ≠ V <sub>CU</sub>	V <sub>CL</sub> - 0.070	$V_{CL}$	V <sub>CL</sub> + 0.040	V	1
Overcharge release voltage	$V_{CL}$	V <sub>CL</sub> = V <sub>CU</sub>	V <sub>CL</sub> - 0.050	V <sub>CL</sub>	V <sub>CL</sub> + 0.030	V	1
Overdischarge detection voltage	$V_{DL}$	-	V <sub>DL</sub> - 0.090	$V_{DL}$	V <sub>DL</sub> + 0.060	V	2
		$V_{DL} \neq V_{DU}$	V <sub>DU</sub> - 0.140	$V_{DU}$	V <sub>DU</sub> + 0.110	V	2
Overdischarge release voltage	$V_{DU}$	$V_{DL} = V_{DU}$	$V_{DU} - 0.090$	$V_{DU}$	$V_{DU} + 0.060$	V	2
		V <sub>DD</sub> = 3.0 V	_	$V_{\text{DIOV}}$	_	V	2
Discharge overcurrent detection voltage*2	$V_{\text{DIOV}}$	V <sub>DD</sub> = 3.4 V	_	$V_{\text{DIOV}}$	-	V	2
		V <sub>DD</sub> = 4.0 V	_	$V_{DIOV}$	-	V	2
Load short-circuiting detection voltage	V <sub>SHORT</sub>	_	V <sub>SHORT</sub> – 0.050		V <sub>SHORT</sub> + 0.050	V	2
Discharge overcurrent release voltage	$V_{RIOV}$	_	$V_{DD}-1.4$	V <sub>DD</sub> – 0.8	$V_{\text{DD}}-0.3$	V	2
Charge overcurrent detection voltage	$V_{\text{CIOV}}$	_	V <sub>CIOV</sub> - 0.015	$V_{\text{CIOV}}$	V <sub>CIOV</sub> + 0.015	V	2
0 V Battery Charge Function							
0 V battery charge starting charger voltage	V <sub>0CHA</sub>	0 V battery charge function "available"	0.00	0.70	1.50	V	2
0 V battery charge inhibition battery voltage	Voinh	0 V battery charge function "unavailable"	0.70	1.25	1.80	٧	2
Internal Resistance	u.		•	1	•	ı	
Resistance between VM pin and VDD pin	$R_{VMD}$	_	250	1000	3000	kΩ	3
Resistance between VM pin and VSS pin	R <sub>VMS</sub>	_	7.2	20	44	kΩ	3
Input Voltage				•			
Operation voltage between VDD pin and	V <sub>DSOP1</sub>		1.5	_	6.5	V	_
VSS pin	V DSOP1	_	1.5	_	0.5	V	
Operation voltage between VDD pin and	$V_{DSOP2}$	_	1.5	_	28	V	_
VM pin	V DSOF2		1.0		20	, , , , , , , , , , , , , , , , , , ,	
Input Current	T	T	T	ı	T	ı	
Current consumption during operation	I <sub>OPE</sub>	_	-	2.0	4.5	μΑ	3
Current consumption during power-down	I <sub>PDN</sub>	_	-	_	100	nΑ	3
Current consumption during overdischarge	I <sub>OPED</sub>	-	_	_	2.0	μА	3
Output Resistance	T	T	T	ı	T	ı	
CO pin resistance "H"	R <sub>COH</sub>	_	2.5	10	30	kΩ	4
CO pin resistance "L"	R <sub>COL</sub>	_	2.5	10	30	kΩ	4
DO pin resistance "H"	R <sub>DOH</sub>	_	2.5	10	30	kΩ	4
DO pin resistance "L"	R <sub>DOL</sub>	_	2.5	10	30	kΩ	4
Delay Time	1	T	T	1	Γ	1	
Overcharge detection delay time	t <sub>CU</sub>	_	$t_{\text{CU}} \times 0.6$	tcu	$t_{\text{CU}} \times 1.6$		5
Overdischarge detection delay time	$t_{DL}$	_	$t_{DL} \times 0.6$	t <sub>DL</sub>	$t_{DL} \times 1.6$	_	5
Discharge overcurrent detection delay time	$t_{\text{DIOV}}$	_	$t_{\text{DIOV}} \times 0.6$	t <sub>DIOV</sub>	$t_{DIOV} \times 1.6$	_	5
Load short-circuiting detection delay time	t <sub>SHORT</sub>	_	$t_{\text{SHORT}} \times 0.5$	t <sub>SHORT</sub>	t <sub>SHORT</sub> × 1.7	_	5
Charge overcurrent detection delay time	t <sub>CIOV</sub>	_	$t_{\text{CIOV}} \times 0.6$	tciov	$t_{\text{CIOV}} \times 1.6$		5
*4 Cinco products are not corpored at high		· · · · · ·	· · · · · ·	_	—		ood by

<sup>\*1.</sup> Since products are not screened at high and low temperature, the specification for this temperature range is guaranteed by design, not tested in production.

<sup>\*2.</sup> The temperature characteristics of V<sub>DIOV</sub> is determined depending on the setting of V<sub>DIOV</sub>, and accords closely with the temperature characteristics of ON resistance of the charge-discharge control FET.

Refer to "2. 5 V<sub>DIOV</sub> vs. Ta" in "■ Characteristics (Typical Data)" for details.

#### ■ Test Circuits

Caution Unless otherwise specified, the output voltage levels "H" and "L" at CO pin ( $V_{CO}$ ) and DO pin ( $V_{DO}$ ) are judged by the threshold voltage (1.0 V) of the N-channel FET. Judge the CO pin level with respect to  $V_{VM}$  and the DO pin level with respect to  $V_{SS}$ .

#### Overcharge detection voltage, overcharge release voltage (Test circuit 1)

Overcharge detection voltage ( $V_{CU}$ ) is defined as the voltage V1 at which  $V_{CO}$  goes from "H" to "L" when the voltage V1 is gradually increased from the starting conditions of V1 = 3.4 V. Overcharge release voltage ( $V_{CL}$ ) is defined as the voltage V1 at which  $V_{CO}$  goes from "L" to "H" when the voltage V1 is then gradually decreased. Overcharge hysteresis voltage ( $V_{HC}$ ) is defined as the difference between  $V_{CU}$  and  $V_{CL}$ .

# 2. Overdischarge detection voltage, overdischarge release voltage (Test circuit 2)

Overdischarge detection voltage ( $V_{DL}$ ) is defined as the voltage V1 at which  $V_{DO}$  goes from "H" to "L" when the voltage V1 is gradually decreased from the starting conditions of V1 = 3.4 V, V2 = 0 V. Overdischarge release voltage ( $V_{DU}$ ) is defined as the voltage V1 at which  $V_{DO}$  goes from "L" to "H" when the voltage V1 is then gradually increased from the starting condition of V2 = 0.02 V. Overdischarge hysteresis voltage ( $V_{HD}$ ) is defined as the difference between  $V_{DU}$  and  $V_{DL}$ .

# 3. Discharge overcurrent detection voltage (Test circuit 2)

Discharge overcurrent detection voltage ( $V_{DIOV}$ ) is defined as the voltage V2 whose delay time for changing  $V_{DO}$  from "H" to "L" is discharge overcurrent detection delay time ( $t_{DIOV}$ ) when the voltage V2 is increased from the starting conditions of V1 = 3.4 V, V2 = 0 V.

# 4. Discharge overcurrent release voltage (Release condition of discharge overcurrent status "load disconnection") (Test circuit 2)

Set V1 = 3.4 V, V2 = 0 V. Discharge overcurrent release voltage ( $V_{RIOV}$ ) is defined as the voltage V2 at which  $V_{DO}$  goes from "L" to "H" when the voltage V2 is then gradually decreased from the starting condition of V2 = 3.4 V.

#### Load short-circuiting detection voltage (Test circuit 2)

Load short-circuiting detection voltage ( $V_{SHORT}$ ) is defined as the voltage V2 whose delay time for changing  $V_{DO}$  from "H" to "L" is load short-circuiting detection delay time ( $t_{SHORT}$ ) when the voltage V2 is increased from the starting conditions of V1 = 3.4 V, V2 = 0 V.

# 6. Charge overcurrent detection voltage (Test circuit 2)

Charge overcurrent detection voltage ( $V_{CIOV}$ ) is defined as the voltage V2 whose delay time for changing  $V_{CO}$  from "H" to "L" is charge overcurrent detection delay time ( $t_{CIOV}$ ) when the voltage V2 is decreased from the starting conditions of V1 = 3.4 V, V2 = 0 V.

# 7. Current consumption during operation (Test circuit 3)

The current consumption during operation ( $I_{OPE}$ ) is the current that flows through the VDD pin ( $I_{DD}$ ) under the set conditions of V1 = 3.4 V, V2 = 0 V.

# 8. Current consumption during power-down, current consumption during overdischarge (Test circuit 3)

#### 8. 1 With power-down function

The current consumption during power-down ( $I_{PDN}$ ) is  $I_{DD}$  under the set condition of V1 = V2 = 1.5 V.

#### 8. 2 Without power-down function

The current consumption during overdischarge ( $I_{OPED}$ ) is  $I_{DD}$  under the set condition of V1 = V2 = 1.5 V.

## 9. Resistance between VM pin and VDD pin

(Test circuit 3)

Resistance between VM pin and VDD pin is  $R_{VMD}$  under the set conditions of V1 = 1.8 V, V2 = 0 V.

# 10. Resistance between VM pin and VSS pin (Release condition of discharge overcurrent status "load disconnection")

(Test circuit 3)

Resistance between VM pin and VSS pin is  $R_{VMS}$  under the set conditions of V1 = 3.4 V, V2 = 1.0 V.

#### 11. CO pin resistance "H"

(Test circuit 4)

The CO pin resistance "H" ( $R_{COH}$ ) is the resistance between VDD pin and CO pin under the set conditions of V1 = 3.4 V, V2 = 0 V, V3 = 3.0 V.

#### 12. CO pin resistance "L"

(Test circuit 4)

The CO pin resistance "L" ( $R_{COL}$ ) is the resistance between VM pin and CO pin under the set conditions of V1 = 4.6 V, V2 = 0 V, V3 = 0.4 V.

#### 13. DO pin resistance "H"

(Test circuit 4)

The DO pin resistance "H" ( $R_{DOH}$ ) is the resistance between VDD pin and DO pin under the set conditions of V1 = 3.4 V, V2 = 0 V, V4 = 3.0 V.

#### 14. DO pin resistance "L"

(Test circuit 4)

The DO pin resistance "L" ( $R_{DOL}$ ) is the resistance between VSS pin and DO pin under the set conditions of V1 = 1.8 V, V2 = 0 V, V4 = 0.4 V.

#### 15. Overcharge detection delay time

(Test circuit 5)

The overcharge detection delay time ( $t_{CU}$ ) is the time needed for  $V_{CO}$  to go to "L" after the voltage V1 increases and exceeds  $V_{CU}$  under the set conditions of V1 = 3.4 V, V2 = 0 V.

#### 16. Overdischarge detection delay time

(Test circuit 5)

The overdischarge detection delay time ( $t_{DL}$ ) is the time needed for  $V_{DO}$  to go to "L" after the voltage V1 decreases and falls below  $V_{DL}$  under the set conditions of V1 = 3.4 V, V2 = 0 V.

# 17. Discharge overcurrent detection delay time (Test circuit 5)

 $t_{\text{DIOV}}$  is the time needed for  $V_{\text{DO}}$  to go to "L" after the voltage V2 increases and exceeds  $V_{\text{DIOV}}$  under the set conditions of V1 = 3.4 V, V2 = 0 V.

# 18. Load short-circuiting detection delay time (Test circuit 5)

 $t_{SHORT}$  is the time needed for  $V_{DO}$  to go to "L" after the voltage V2 increases and exceeds  $V_{SHORT}$  under the set conditions of V1 = 3.4 V, V2 = 0 V.

# 19. Charge overcurrent detection delay time (Test circuit 5)

 $t_{CIOV}$  is the time needed for  $V_{CO}$  to go to "L" after the voltage V2 decreases and falls below  $V_{CIOV}$  under the set conditions of V1 = 3.4 V, V2 = 0 V.

# 20. 0 V battery charge starting charger voltage (0 V battery charge function "available") (Test circuit 2)

The 0 V battery charge starting charger voltage ( $V_{0CHA}$ ) is defined as absolute value of the voltage V2 at which  $V_{CO}$  goes to "H" ( $V_{CO} = V_{DD}$ ) when the voltage V2 is gradually decreased under the set condition of V1 = V2 = 0 V.

# 21. 0 V battery charge inhibition battery voltage (0 V battery charge function "unavailable") (Test circuit 2)

The 0 V battery charge inhibition battery voltage ( $V_{0INH}$ ) is defined as the voltage V1 at which  $V_{CO}$  goes to "H" ( $V_{CO}$  =  $V_{DD}$ ) when the voltage V1 is gradually increased under the set conditions of V1 = 0 V, V2 = -2.0 V.

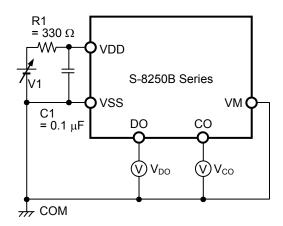


Figure 4 Test Circuit 1

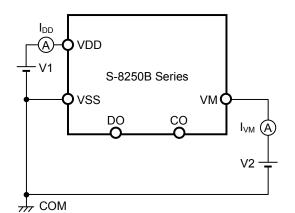


Figure 6 Test Circuit 3

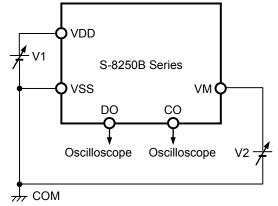


Figure 8 Test Circuit 5

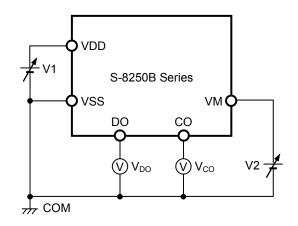


Figure 5 Test Circuit 2

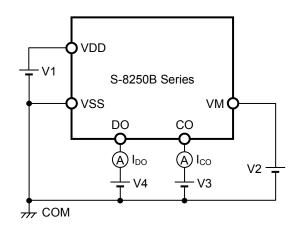


Figure 7 Test Circuit 4

#### Operation

Remark Refer to "■ Battery Protection IC Connection Example".

#### 1. Normal status

The S-8250B Series monitors the voltage of the battery connected between the VDD pin and VSS pin and the voltage between the VM pin and VSS pin to control charging and discharging. When the battery voltage is in the range from the overdischarge detection voltage ( $V_{DL}$ ) to the overcharge detection voltage ( $V_{CU}$ ), and the VM pin voltage is in the range from the charge overcurrent detection voltage ( $V_{CIOV}$ ) to the discharge overcurrent detection voltage ( $V_{DIOV}$ ), the S-8250B Series turns both the charge and discharge control FETs on. This condition is called the normal status, and in this condition charging and discharging can be carried out freely.

The resistance between the VM pin and VDD pin ( $R_{VMD}$ ) and the resistance between the VM pin and VSS pin ( $R_{VMS}$ ) are not connected in the normal status.

Caution When the battery is connected for the first time, the S-8250B Series may not be in the normal status. In this case, short the VM pin and VSS pin, or set the VM pin voltage at the level of  $V_{\text{DIOV}}$  or more and at the level of  $V_{\text{DIOV}}$  or less by connecting the charger. The S-8250B Series then becomes the normal status.

#### 2. Overcharge status

#### 2. 1 V<sub>CL</sub> ≠ V<sub>CU</sub> (Product in which overcharge release voltage differs from overcharge detection voltage)

When the battery voltage becomes higher than  $V_{\text{CU}}$  during charging in the normal status and detection continues for the overcharge detection delay time ( $t_{\text{CU}}$ ) or longer, the S-8250B Series turns the charge control FET off to stop charging. This condition is called the overcharge status.

The overcharge status is released in the following two cases.

- (1) In the case that the VM pin voltage is lower than  $V_{DIOV}$ , the S-8250B Series releases the overcharge status when the battery voltage falls below overcharge release voltage ( $V_{CL}$ ).
- (2) In the case that the VM pin voltage is equal to or higher than  $V_{DIOV}$ , the S-8250B Series releases the overcharge status when the battery voltage falls below  $V_{CU}$ .

When the discharge is started by connecting a load after the overcharge detection, the VM pin voltage rises by the  $V_f$  voltage of the parasitic diode than the VSS pin voltage, because the discharge current flows through the parasitic diode in the charge control FET. If this VM pin voltage is equal to or higher than  $V_{DIOV}$ , the S-8250B Series releases the overcharge status when the battery voltage is equal to or lower than  $V_{CU}$ .

Caution If the battery is charged to a voltage higher than  $V_{\text{CU}}$  and the battery voltage does not fall below  $V_{\text{CU}}$  even when a heavy load is connected, discharge overcurrent detection and load short-circuiting detection do not function until the battery voltage falls below  $V_{\text{CU}}$ . Since an actual battery has an internal impedance of tens of  $m\Omega$ , the battery voltage drops immediately after a heavy load that causes overcurrent is connected, and discharge overcurrent detection and load short-circuiting detection function.

#### 2. 2 V<sub>CL</sub> = V<sub>CU</sub> (Product in which overcharge release voltage is the same as overcharge detection voltage)

When the battery voltage becomes higher than  $V_{\text{CU}}$  during charging in the normal status and detection continues for the overcharge detection delay time ( $t_{\text{CU}}$ ) or longer, the S-8250B Series turns the charge control FET off to stop charging. This condition is called the overcharge status.

In the case that the VM pin voltage is higher than 0 V typ., the S-8250B Series releases the overcharge status when the battery voltage falls below  $V_{\text{CU}}$ .

- Caution 1. If the battery is charged to a voltage higher than  $V_{\text{CU}}$  and the battery voltage does not fall below  $V_{\text{CU}}$  even when a heavy load is connected, discharge overcurrent detection and load short-circuiting detection do not function until the battery voltage falls below  $V_{\text{CU}}$ . Since an actual battery has an internal impedance of tens of  $m\Omega$ , the battery voltage drops immediately after a heavy load that causes overcurrent is connected, and discharge overcurrent detection and load short-circuiting detection function.
  - 2. When a charger is connected after overcharge detection, the overcharge status is not released even if the battery voltage is below  $V_{CL}$ . The overcharge status is released when the VM pin voltage goes over 0 V typ. by removing the charger.

#### 3. Overdischarge status

When the battery voltage falls below  $V_{DL}$  during discharging in the normal status and the condition continues for the overdischarge detection delay time ( $t_{DL}$ ) or longer, the S-8250B Series turns the discharge control FET off to stop discharging. This condition is called the overdischarge status.

Under the overdischarge status, VDD pin and VM pin are shorted by  $R_{VMD}$  in the S-8250B Series. The VM pin voltage is pulled up by  $R_{VMD}$ .

R<sub>VMS</sub> is not connected in the overdischarge status.

#### 3. 1 With power-down function

Under the overdischarge status, when voltage difference between VDD pin and VM pin is 0.8 V typ. or lower, the power-down function works and the current consumption is reduced to the current consumption during power-down ( $I_{PDN}$ ). By connecting a battery charger, the power-down function is released when the VM pin voltage is 0.7 V typ. or lower.

- When a battery is not connected to a charger and the VM pin voltage ≥ 0.7 V typ., the S-8250B Series maintains the overdischarge status even when the battery voltage reaches V<sub>DU</sub> or higher.
- When a battery is connected to a charger and 0.7 V typ. > the VM pin voltage > 0 V typ., the battery voltage reaches V<sub>DII</sub> or higher and the S-8250B Series releases the overdischarge status.
- When a battery is connected to a charger and 0 V typ. ≥ the VM pin voltage, the battery voltage reaches V<sub>DL</sub> or higher and the S-8250B Series releases the overdischarge status.

#### 3. 2 Without power-down function

Under the overdischarge status, the power-down function does not work even when voltage difference between VDD pin and VM pin is 0.8 V typ. or lower.

- When a battery is not connected to a charger and the VM pin voltage ≥ 0.7 V typ., the battery voltage reaches V<sub>DU</sub> or higher and the S-8250B Series releases the overdischarge status.
- When a battery is connected to a charger and 0.7 V typ. > the VM pin voltage > 0 V typ., the battery voltage reaches  $V_{DU}$  or higher and the S-8250B Series releases the overdischarge status.
- When a battery is connected to a charger and 0 V typ. ≥ the VM pin voltage, the battery voltage reaches V<sub>DL</sub> or higher and the S-8250B Series releases the overdischarge status.

#### 4. Discharge overcurrent status (Discharge overcurrent, load short-circuiting)

When a battery in the normal status is in the status where the VM pin voltage is equal to or higher than  $V_{DIOV}$  because the discharge current is equal to or higher than the specified value and the status lasts for the discharge overcurrent detection delay time ( $t_{DIOV}$ ) or longer, the discharge control FET is turned off and discharging is stopped. This status is called the discharge overcurrent status.

#### 4. 1 Release condition of discharge overcurrent status "load disconnection"

In the discharge overcurrent status, the VM pin and VSS pin are shorted by  $R_{VMS}$  in the S-8250B Series. However, the VM pin voltage is the VDD pin voltage due to the load as long as the load is connected. When the load is disconnected, the VM pin voltage returns to the VSS pin voltage. If the VM pin voltage returns to the discharge overcurrent release voltage ( $V_{RIOV}$ ) or lower, the S-8250B Series releases the discharge overcurrent status.

R<sub>VMD</sub> is not connected in the discharge overcurrent status.

#### 4. 2 Release condition of discharge overcurrent status "charger connection"

In the discharge overcurrent status, the VM pin and VDD pin are shorted by R<sub>VMD</sub> in the S-8250B Series.

If the VM pin voltage returns to  $V_{\text{DIOV}}$  or lower by connecting a charger, the S-8250B Series releases the discharge overcurrent status.

R<sub>VMS</sub> is not connected in the discharge overcurrent status.

#### 5. Charge overcurrent status

When a battery in the normal status is in the status where the VM pin voltage is equal to or lower than  $V_{\text{CIOV}}$  because the charge current is equal to or higher than the specified value and the status lasts for the charge overcurrent detection delay time ( $t_{\text{CIOV}}$ ) or longer, the charge control FET is turned off and charging is stopped. This status is called the charge overcurrent status.

The S-8250B Series releases the charge overcurrent status when the VM pin voltage returns to 0 V typ. or higher by removing the charger.

The charge overcurrent detection does not function in the overdischarge status.

#### 6. 0 V battery charge function "available"

This function is used to recharge a connected battery whose voltage is 0 V due to self-discharge. When the 0 V battery charge starting charger voltage ( $V_{\text{OCHA}}$ ) or a higher voltage is applied between the EB+ pin and EB- pin by connecting a charger, the charge control FET gate is fixed to the VDD pin voltage. When the voltage between the gate and source of the charge control FET becomes equal to or higher than the threshold voltage due to the charger voltage, the charge control FET is turned on to start charging. At this time, the discharge control FET is off and the charge current flows through the internal parasitic diode in the discharge control FET. When the battery voltage becomes equal to or higher than  $V_{\text{DU}}$ , the S-8250B Series enters the normal status.

- Caution 1. Some battery providers do not recommend charging for a completely self-discharged battery. Please ask the battery provider to determine whether to enable or inhibit the 0 V battery charge function.
  - 2. The 0 V battery charge function has higher priority than the charge overcurrent detection function. Consequently, a product in which use of the 0 V battery charge function is enabled charges a battery forcibly and the charge overcurrent cannot be detected when the battery voltage is lower than  $V_{DL}$ .

#### 7. 0 V battery charge function "unavailable"

This function inhibits recharging when a battery that is internally short-circuited (0 V battery) is connected. When the battery voltage is the 0 V battery charge inhibition battery voltage ( $V_{0INH}$ ) or lower, the charge control FET gate is fixed to the EB- pin voltage to inhibit charging. When the battery voltage is  $V_{0INH}$  or higher, charging can be performed.

Caution Some battery providers do not recommend charging for a completely self-discharged battery. Please ask the battery provider to determine whether to enable or inhibit the 0 V battery charge function.

#### 8. Delay circuit

The detection delay times are determined by dividing a clock of approximately 4 kHz by the counter.

**Remark**  $t_{DIOV}$  and  $t_{SHORT}$  start when  $V_{DIOV}$  is detected. When  $V_{SHORT}$  is detected over  $t_{SHORT}$  after  $V_{DIOV}$ , the S-8250B Series turns the discharge control FET off within  $t_{SHORT}$  from the time of detecting  $V_{SHORT}$ .

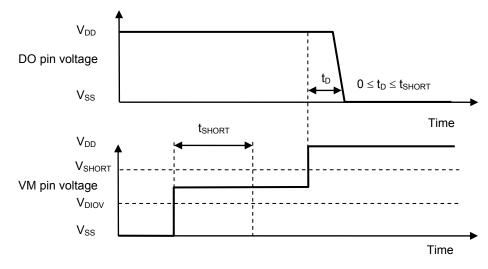
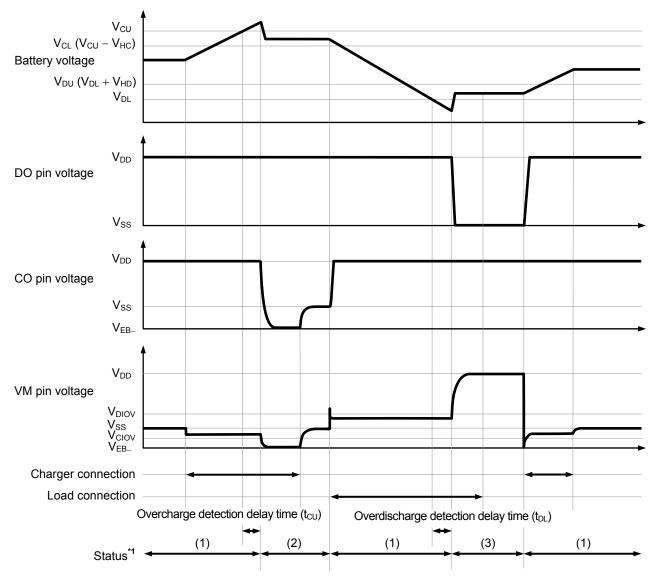


Figure 9

# **■** Timing Chart

### 1. Overcharge detection, overdischarge detection



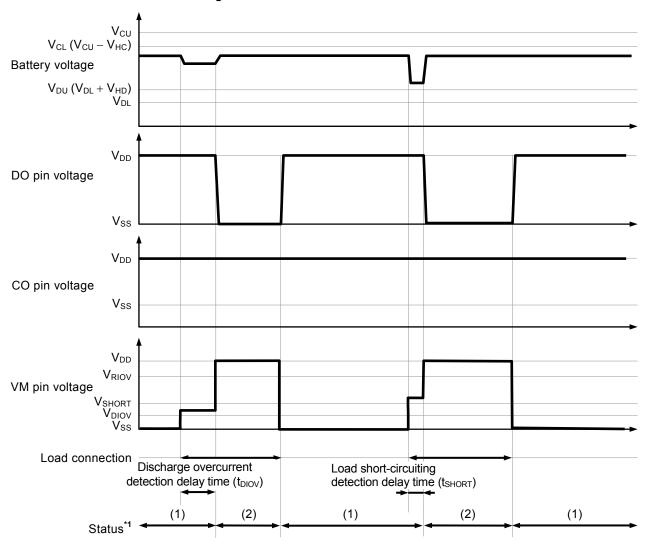
- \*1. (1): Normal status
  - (2): Overcharge status
  - (3): Overdischarge status

Remark The charger is assumed to charge with a constant current.

Figure 10

### 2. Discharge overcurrent detection

#### 2. 1 Release condition of discharge overcurrent status "load disconnection"



<sup>\*1. (1):</sup> Normal status

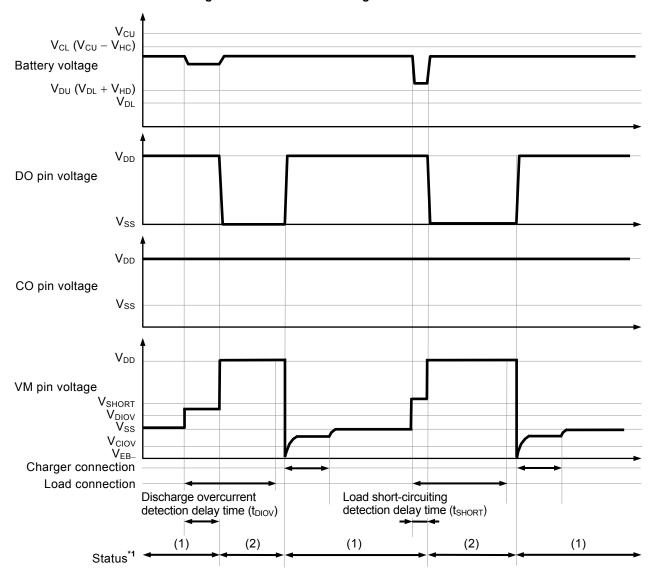
18

Remark The charger is assumed to charge with a constant current.

Figure 11

<sup>(2):</sup> Discharge overcurrent status

#### 2. 2 Release condition of discharge overcurrent status "charger connection"



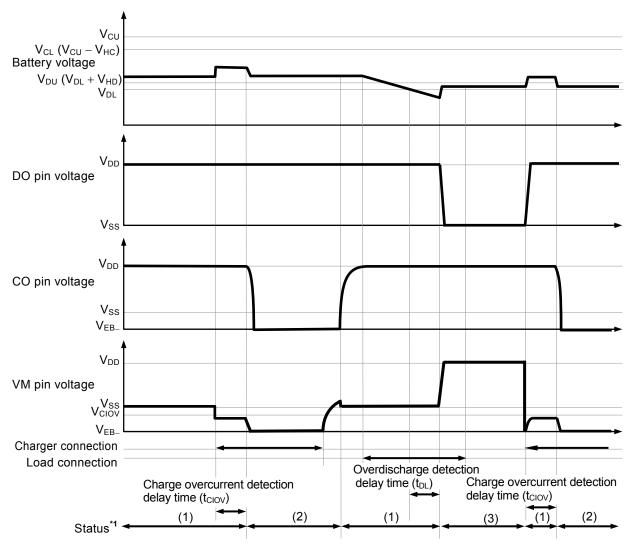
\*1. (1): Normal status

(2): Discharge overcurrent status

**Remark** The charger is assumed to charge with a constant current.

Figure 12

#### 3. Charge overcurrent detection



- \*1. (1): Normal status
  - (2): Charge overcurrent status
  - (3): Overdischarge status

**Remark** The charger is assumed to charge with a constant current.

Figure 13

### ■ Battery Protection IC Connection Example

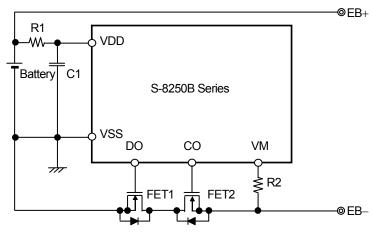


Figure 14

**Table 10 Constants for External Components** 

Symbol	Part	Purpose	Min.	Тур.	Max.	Remark
FET1	N-channel MOS FET	Discharge control	-	ı	-	Threshold voltage ≤ Overdischarge detection voltage*1 Gate to source withstand voltage ≥ Charger voltage*2
FET2	N-channel MOS FET	Charge control	_	Ι	-	Threshold voltage ≤ Overdischarge detection voltage *1 Gate to source withstand voltage ≥ Charger voltage*2
R1	Resistor	ESD protection, For power fluctuation	150 Ω	330 Ω	510 Ω	Resistance should be as small as possible to avoid worsening the overcharge detection accuracy due to current consumption.*3
C1	Capacitor	For power fluctuation	0.068 μF	0.1 μF	1.0 μF	Connect a capacitor of 0.068 μF or higher between VDD pin and VSS pin.*4
R2	Resistor	Protection for reverse connection of a charger	1 kΩ	2 kΩ	4 kΩ	Select as large a resistance as possible to prevent current when a charger is connected in reverse.*5

<sup>\*1.</sup> If the threshold voltage of a FET is low, the FET may not cut the charge current. If a FET with a threshold voltage equal to or higher than the overdischarge detection voltage is used, discharging may be stopped before overdischarge is detected.

- \*2. If the withstand voltage between the gate and source is lower than the charger voltage, the FET may be destroyed.
- \*3. An accuracy of overcharge detection voltage is guaranteed by R1 = 330  $\Omega$ . Connecting resistors with other values worsen the accuracy. In case of connecting a larger resistor to R1, the voltage between the VDD pin and VSS pin may exceed the absolute maximum rating because the current flows to the S-8250B Series from the charger due to reverse connection of charger. Connect a resistor of 150  $\Omega$  or more to R1 for ESD protection.
- **\*4.** When connecting a resistor less than 150  $\Omega$  to R1 or a capacitor less than 0.068  $\mu$ F to C1, the S-8250B Series may malfunction when power dissipation is largely fluctuated.
- \*5. When a resistor more than 4 k $\Omega$  is connected to R2, the charge current may not be cut.

#### Caution 1. The above constants may be changed without notice.

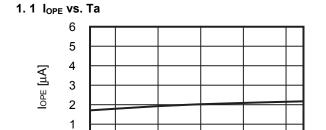
It has not been confirmed whether the operation is normal or not in circuits other than the above example of connection. In addition, the example of connection shown above and the constant do not guarantee proper operation. Perform thorough evaluation using the actual application to set the constant.

#### ■ Precautions

- The application conditions for the input voltage, output voltage, and load current should not exceed the package power dissipation.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- ABLIC Inc. claims no responsibility for any and all disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

# ■ Characteristics (Typical Data)

#### 1. Current consumption



0

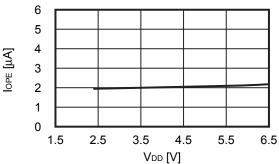
25

Ta [°C]

50

75 85

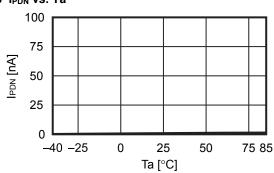
1. 2 I<sub>OPE</sub> vs. V<sub>DD</sub>



1. 3 I<sub>PDN</sub> vs. Ta

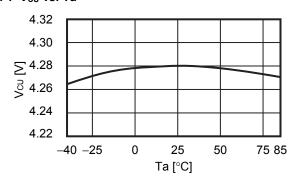
0

-40 -25

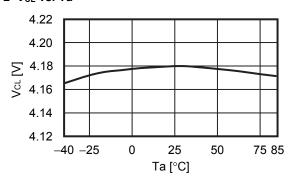


#### 2. Detection voltage

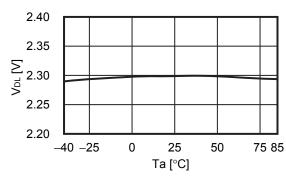
2. 1 V<sub>CU</sub> vs. Ta



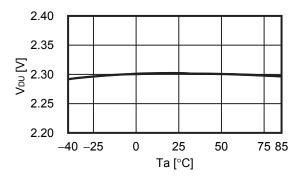
2. 2 V<sub>CL</sub> vs. Ta



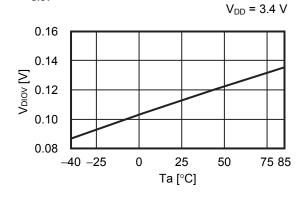
2. 3 V<sub>DL</sub> vs. Ta



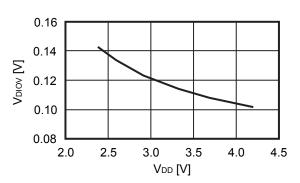
2. 4 V<sub>DU</sub> vs. Ta



2. 5  $\,V_{\text{DIOV}}\,\,vs.\,Ta$ 

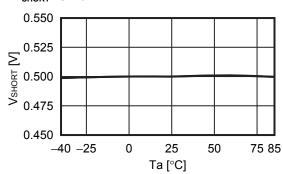


### 2. 6 V<sub>DIOV</sub> vs. V<sub>DD</sub>

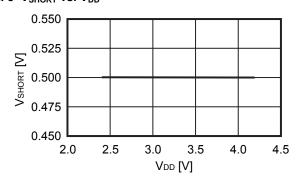


 $n = 1 \sim 3$ 

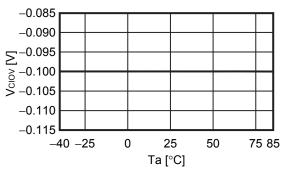
2. 7 V<sub>SHORT</sub> vs. Ta



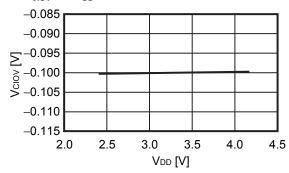
#### 2. 8 V<sub>SHORT</sub> vs. V<sub>DD</sub>







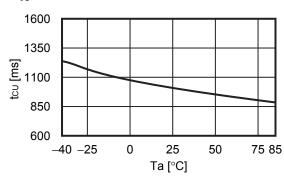
#### 2. 10 $V_{\text{CIOV}}$ vs. $V_{\text{DD}}$



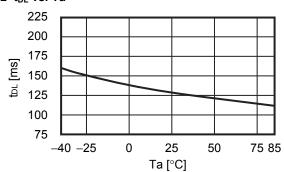
24 ABLIC Inc.

#### 3. Delay time

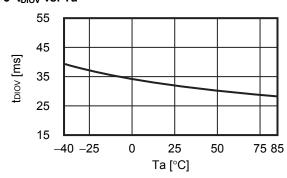
#### 3. 1 t<sub>CU</sub> vs. Ta



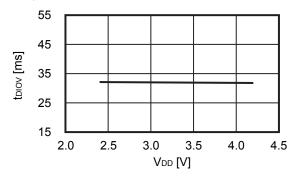
#### 3. 2 t<sub>DL</sub> vs. Ta



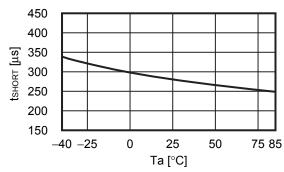
3. 3 t<sub>DIOV</sub> vs. Ta



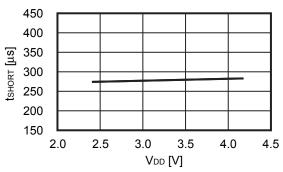
#### 3. 4 $t_{\text{DIOV}}$ vs. $V_{\text{DD}}$



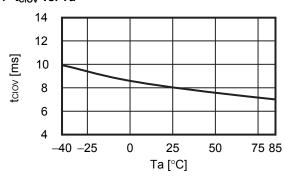
3. 5 t<sub>SHORT</sub> vs. Ta



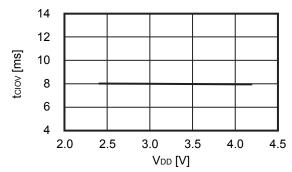
3. 6 t<sub>SHORT</sub> vs. V<sub>DD</sub>



3. 7 t<sub>CIOV</sub> vs. Ta

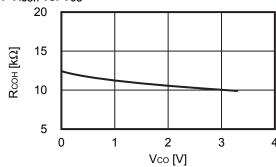


3. 8 t<sub>CIOV</sub> vs. V<sub>DD</sub>

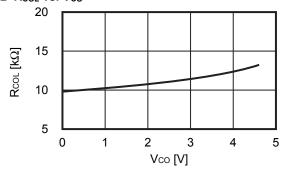


### 4. Output resistance

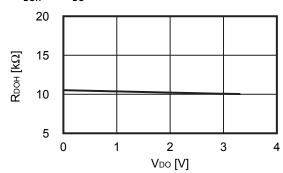
### 4. 1 R<sub>COH</sub> vs. V<sub>CO</sub>



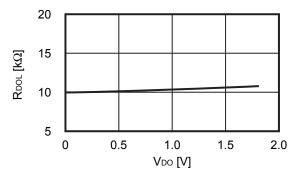
4. 2 R<sub>COL</sub> vs. V<sub>CO</sub>



4. 3  $R_{DOH}$  vs.  $V_{DO}$ 



4. 4  $R_{DOL}$  vs.  $V_{DO}$ 



# ■ Marking Specification

### 1. SNT-6A

Top view

6 5 4

(1) (2) (3)

(4) (5) (6)

1 2 3

(1) to (3): Product code (refer to **Product name vs. Product code**)

(4) to (6): Lot number

#### Product name vs. Product code

Product Name	Pı	Product Code					
Product Name	(1)	(2)	(3)				
S-8250BAB-I6T1U	4	0	В				
S-8250BAC-I6T1U	4	0	С				
S-8250BAF-I6T1U	4	0	F				
S-8250BAK-I6T1U	4	0	K				
S-8250BAL-I6T1U	4	0	L				
S-8250BAM-I6T1U	4	0	М				
S-8250BAN-I6T1U	4	0	N				
S-8250BAS-I6T1U	4	0	S				
S-8250BAV-I6T1U	4	0	V				





# No. PG006-A-P-SD-2.1

TITLE	SNT-6A-A-PKG Dimensions	
No.	PG006-A-P-SD-2.1	
ANGLE	<b>\$</b> E3	
UNIT	mm	
ABLIC Inc.		





# No. PG006-A-C-SD-2.0

TITLE	SNT-6A-A-Carrier Tape		
No.	PG006-A-C-SD-2.0		
ANGLE			
UNIT	mm		
ABLIC Inc.			



TITLE	SNT-6A-A-Reel			
No.	PG006-A-R-SD-1.0			
ANGLE		QTY.	5,000	
UNIT	mm			
ABLIC Inc.				



%1. ランドパターンの幅に注意してください (0.25 mm min. / 0.30 mm typ.)。 %2. パッケージ中央にランドパターンを広げないでください (1.30 mm ~ 1.40 mm)。

- 注意 1. パッケージのモールド樹脂下にシルク印刷やハンダ印刷などしないでください。
  - 2. パッケージ下の配線上のソルダーレジストなどの厚みをランドパターン表面から0.03 mm 以下にしてください。
  - 3. マスク開口サイズと開口位置はランドパターンと合わせてください。
  - 4. 詳細は "SNTパッケージ活用の手引き"を参照してください。
- ※1. Pay attention to the land pattern width (0.25 mm min. / 0.30 mm typ.).
- ※2. Do not widen the land pattern to the center of the package (1.30 mm ~ 1.40 mm).
- Caution 1. Do not do silkscreen printing and solder printing under the mold resin of the package.
  - 2. The thickness of the solder resist on the wire pattern under the package should be 0.03 mm or less from the land pattern surface.
  - 3. Match the mask aperture size and aperture position with the land pattern.
  - 4. Refer to "SNT Package User's Guide" for details.
- ※1. 请注意焊盘模式的宽度 (0.25 mm min. / 0.30 mm typ.)。
- ※2. 请勿向封装中间扩展焊盘模式 (1.30 mm ~ 1.40 mm)。
- 注意 1. 请勿在树脂型封装的下面印刷丝网、焊锡。
  - 2. 在封装下、布线上的阻焊膜厚度 (从焊盘模式表面起) 请控制在 0.03 mm 以下。
  - 3. 钢网的开口尺寸和开口位置请与焊盘模式对齐。
  - 4. 详细内容请参阅 "SNT 封装的应用指南"。

No. PG006-A-L-SD-4.1

TITLE	SNT-6A-A -Land Recommendation		
No.	PG006-A-L-SD-4.1		
ANGLE			
UNIT	mm		
ARLIC Inc			

ABLIC Inc.

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  - ABLIC Inc. is not responsible for damages caused by failures and / or accidents, etc. that occur due to the use of the products outside their specified ranges.
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  - The user of the products should therefore take responsibility to give thorough consideration to safety design including redundancy, fire spread prevention measures, and malfunction prevention to prevent accidents causing injury or death, fires and social damage, etc. that may ensue from the products' failure or malfunction.
  - The entire system must be sufficiently evaluated and applied on customer's own responsibility.
- 10. The products are not designed to be radiation-proof. The necessary radiation measures should be taken in the product design by the customer depending on the intended use.
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